

Features

- · Trench LV MOSFET Technology
- ESD HBM Class 2
- · Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

N-Channel MOSFET

Maximum Ratings

- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 150°C/W Junction to Ambient^(Note 2)

Parameter	Symbol	Rating	Unit		
Drain-Source Voltage	V _{DS}	25	V		
Gate-Source Volltage		V _{GS}	±20	V	
Continuous Drain Current	T _A =25°C	- I _D	0.98	Α	
	T _A =100°C		0.61		
Pulsed Drain Current ^(Note 3)		I _{DM}	3.92	Α	
Total Power Dissipation (Note 4)		P _D	0.83	W	

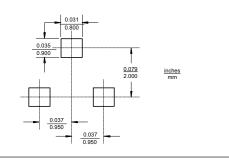
Note:

- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. The value of $R_{\theta JA}$ is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.
- 3. Repetitive rating; pulse width limited by max. junction temperature.
- 4. $\ensuremath{\text{P}_{\text{D}}}$ is based on max. junction temperature, using junction-ambient thermal resistance.

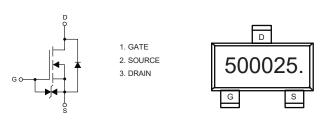
SOT-23

DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	NOIL
Α	0.110	0.120	2.80	3.04	
В	0.083	0.104	2.10	2.64	
С	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
E	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.006	0.01	0.15	
Н	0.035	0.043	0.90	1.10	
J	0.003	0.007	0.08	0.18	
K	0.012	0.020	0.30	0.51	
L	0.007	0.020	0.20	0.50	

Suggested Solder Pad Layout



Internal Structure and Marking Code



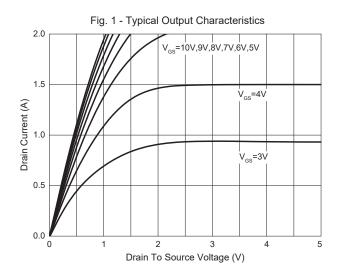


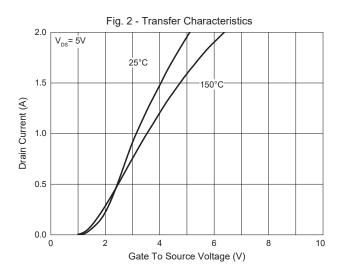
ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

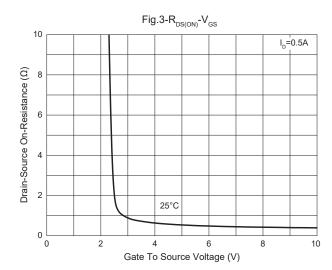
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit	
Static Characteristics			I	1	ı		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	25			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_D=250\mu A$	0.6	0.85	1.05	V	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±10	μA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =25V, V _{GS} =0V			1	μA	
Drain-Source On-Resistance		V _{GS} =10V, I _D =0.5A		390	500		
	R _{DS(on)}	V _{GS} =4.5V, I _D =0.3A		565	735	mΩ	
		V _{GS} =2.5V, I _D =0.2A		1020	1325		
Gate Resistance	R _g	f=1 MHz, Open drain		118		Ω	
Diode Characteristics			,				
Continuous Body Diode Current	Is				0.98	Α	
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =0.5A			1.2	V	
Reverse Recovery Time	t _{rr}	IT-0 FA di /dt-100A/		8.9		nS	
Reverse Recovery Charge	Q _{rr}	IF=0.5A, dI _F /dt=100A/µs		2.7		nC	
Dynamic Characteristics				•			
Input Capacitance	C _{iss}			14.3		pF	
Output Capacitance	C _{oss}	V_{DS} =12.5V, V_{GS} =0V,f=1MHz		9.0			
Reverse Transfer Capacitance	C _{rss}			4.0			
Total Gate Charge	Qg			0.8			
Gate-Source Charge	Q_{gs}	V_{DS} =12.5V, V_{GS} =10V, I_{D} =0.5A		0.07		nC	
Gate-Drain Charge	Q_{gd}			0.08			
Turn-On Delay Time	t _{d(on)}			2.0			
Turn-On Rise Time	t _r	\/ -12.5\/\/ -10\/		2.6		ns	
Turn-Off Delay Time	$t_{d(off)}$	V_{DD} =12.5V, V_{GS} =10V, I_{D} =0.5A, R_{G} =3 Ω		7.0		113	
Turn-Off Fall Time	t _f			5.4			

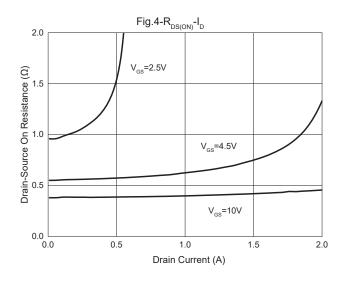


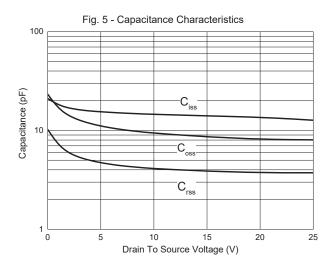
Curve Characteristics

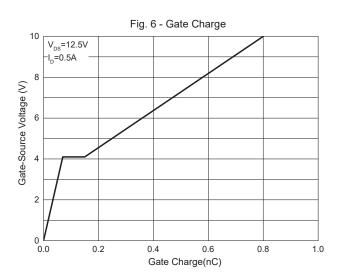






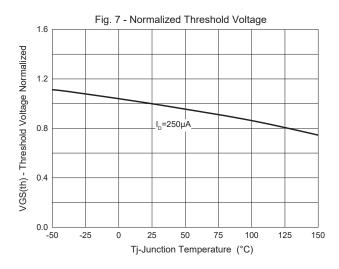


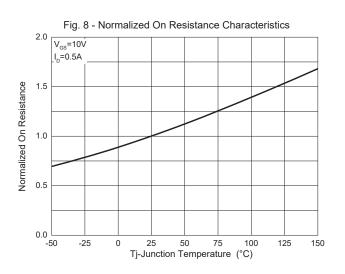


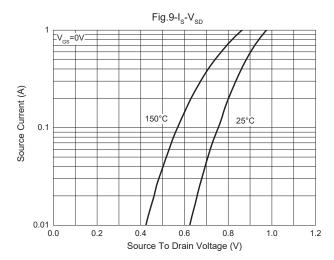


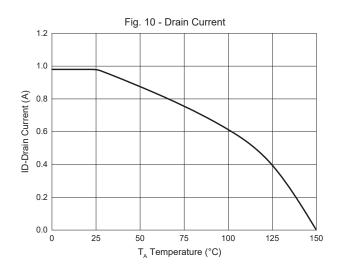


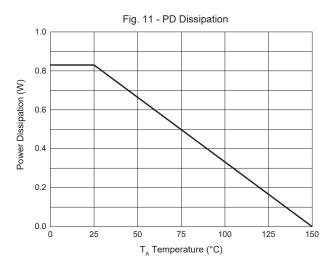
Curve Characteristics













Curve Characteristics

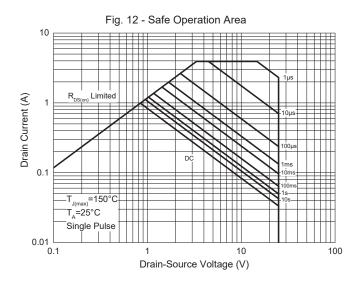
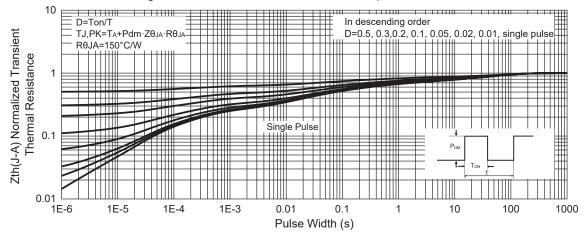


Fig. 13 - Normalized Transient Thermal Impedance





Ordering Information

Device	Packing	
Part Number-TP	Tape&Reel:3Kpcs/Reel	

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